ocket No.

Armstrong, Kratz, Quintos, Hanson & Brooks, LLP

## **DECLARATION FOR U.S. PATENT APPLICATION**

As a below named inventor, I hereby declare that:

(Application Serial No.)

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

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the specification	of which is attached hereto unless	the following is checke	d	
was file		<del>-</del>	Application Number or PCT Internation	al Application
Number				if applicable).
Tvainioe		and was unichaed on		п аррпсаоте).
	at I have reviewed and understand amendment referred to above.	the contents of the above	e-identified specification, including the	claim(s), as
I acknowledge th Regulations, § 1.	-	ich is material to patenta	ability as defined in Title 37, Code of F	ederal
inventor's certifi		entified below any foreig	§ 119 (a) - (d) of any foreign application application for patent or inventor's co	
				Priority Claimed
(List prior	Parent Application	T.	25/11/2002	37
foreign applications.	2002-341046 (Number)	Japan (Country)	25/11/2002 (Day/Month/Year Filed)	$\underline{X}$ Yes $\underline{\hspace{1em}}$ No
See note A)	(Number)	(Country)	(Day/Mondy real riled)	Vac. Na
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	(Number)	(Country)	(Day/Month/Year Filed)	37 37
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	(Number)	(Country)	(Day/Month/Year Filed)	
	(Number)	(Country)	(Day/Month/Year Filed)	_Yes _No
	(Number)	(Country)	(Day/Month/ real Filed)	
(See note B)	See attached list for additio	nal prior foreign applica	tions	
the subject matte provided by the i material to paten	er of each of the claims of this app first paragraph of Title 35, United	tication is not disclosed i States Code, § 112, I ack le of Federal Regulations	United States application(s) listed below the prior United States application in the prior United States application in the prior United States application in the prior United States application.  Status	the manner tion which is
(List prior U.S.			Status	
applications)	(A 1' . A'	(Fil D)	Patented Pending	Abandoned
	(Application Serial No.)	(Filing Date)		
			Patented Pending	Abandoned
	(Application Serial No.)	(Filing Date)		
	<del></del>		Patented Pending	Abandoned
	(Application Serial No.)	(Filing Date)		
			Patented Pending	Abandoned

(Filing Date)



I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, § 1001 and that such willful false statements my jeopardize the validity of the application or any patent issued thereon.

(See note C)	Full name of sole or first inventor (given name, family name)_	Katsutoshi IZUMI		
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Ianan	

## **NOTES**

- A. Please list all foreign applications relating to the invention and check "yes" or "no."
- B. If more than 4 prior foreign applications, please check this box and attach a sheet listing the remaining prior foreign applications.
- C. For residence in the U.S., indicate <u>city and state</u>, for residence outside the U.S., indicate <u>city and country</u>. The "Post Office Address" must be an address acceptable by a Post Office for delivery of mail.